# **NTS0104**

# Dual supply translating transceiver; open drain; auto direction sensing

Rev. 3 — 3 January 2012

**Product data sheet** 

# 1. General description

The NTS0104 is a 4-bit, dual supply translating transceiver with auto direction sensing, that enables bidirectional voltage level translation. It features two 4-bit input-output ports (An and Bn), one output enable input (OE) and two supply pins ( $V_{CC(A)}$  and  $V_{CC(B)}$ ).  $V_{CC(A)}$  can be supplied at any voltage between 1.65 V and 3.6 V and  $V_{CC(B)}$  can be supplied at any voltage between 2.3 V and 5.5 V, making the device suitable for translating between any of the voltage nodes (1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins An and OE are referenced to  $V_{CC(A)}$  and pins Bn are referenced to  $V_{CC(B)}$ . A LOW level at pin OE causes the outputs to assume a high-impedance OFF-state. This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

# 2. Features and benefits

- Wide supply voltage range:
  - ♦ V<sub>CC(A)</sub>: 1.65 V to 3.6 V and V<sub>CC(B)</sub>: 2.3 V to 5.5 V
- Maximum data rates:
  - ◆ Push-pull: 50 Mbps
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Inputs accept voltages up to 5.5 V
- ESD protection:
  - ◆ HBM JESD22-A114E Class 2 exceeds 2500 V for A port
  - ◆ HBM JESD22-A114E Class 3B exceeds 8000 V for B port
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1500 V (For NTS0104UK 1000 V)
  - ◆ IEC61000-4-2 contact discharge exceeds 8000 V for B port
- Latch-up performance exceeds 100 mA per JESD 78B Class II
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# 3. Applications

- I<sup>2</sup>C/SMBus
- UART
- GPIO



# Dual supply translating transceiver; open drain; auto direction sensing

# 4. Ordering information

Table 1. Ordering information

Type number	Package	Package							
	Temperature range	Name	Description	Version					
NTS0104PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1					
NTS0104BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 $\times$ 3 $\times$ 0.85 mm	SOT762-1					
NTS0104GU12	–40 °C to +125 °C	XQFN12	plastic, extremely thin quad flat package; no leads; 12 terminals; body 1.70 ´ 2.0 ´ 0.50 mm	SOT1174-1					
NTS0104UK	–40 °C to +125 °C	WLCSP12	wafer level chip scale package; 12 balls; 1.2 x 1.6 x 0.56 mm	NTS0104UK					

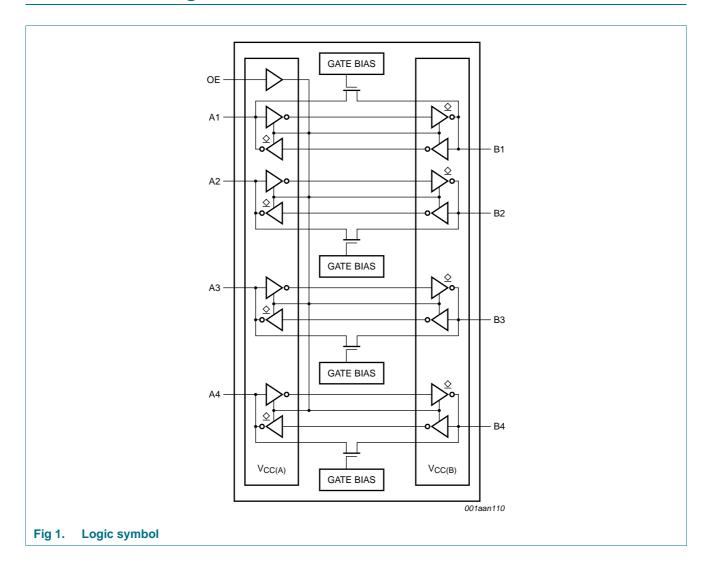
# 5. Marking

### Table 2. Marking

Type number	Marking code
NTS0104PW	NTS0104
NTS0104BQ	S0104
NTS0104GU12	s4
NTS0104UK	s04

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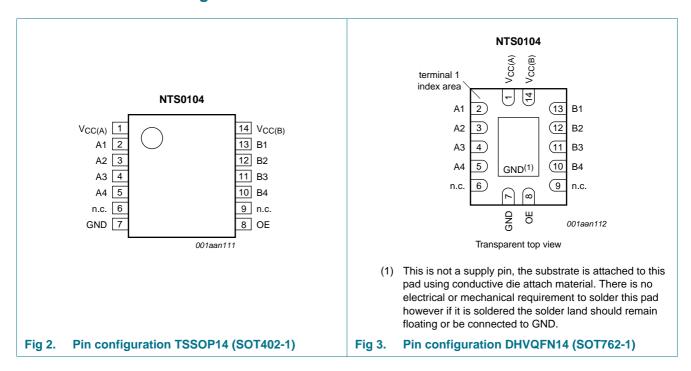
# 6. Functional diagram

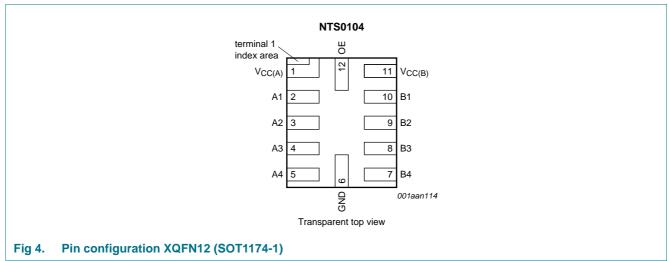


### Dual supply translating transceiver; open drain; auto direction sensing

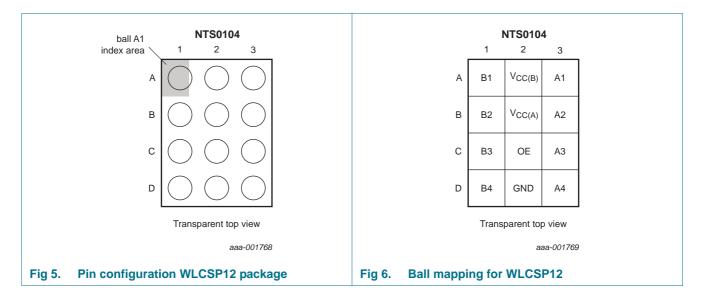
# 7. Pinning information

### 7.1 Pinning





# Dual supply translating transceiver; open drain; auto direction sensing



# 7.2 Pin description

Table 3. Pin description

Symbol	Pin		Ball	Description
	SOT402-1 and SOT762-1	SOT1174-1	WLCSP12	_
$V_{CC(A)}$	1	1	B2	supply voltage A
A1, A2, A3, A4	2, 3, 4, 5	2, 3, 4, 5	A3, B3, C3, D3	data input or output (referenced to $V_{\text{CC}(A)}$ )
n.c.	6, 9	-	-	not connected
GND	7	6	D2	ground (0 V)
OE	8	12	C2	output enable input (active HIGH; referenced to $V_{\text{CC(A)}}$ )
B4, B3, B2, B1	10, 11, 12, 13	7, 8, 9, 10	D1, C1, B1, A1	data input or output (referenced to $V_{\text{CC}(B)}$ )
V <sub>CC(B)</sub>	14	11	A2	supply voltage B

# 8. Functional description

Table 4. Function table[1]

Supply voltage		Input	Input/output	
V <sub>CC(A)</sub> V <sub>CC(B)</sub>		OE	An	Bn
1.65 V to $V_{\text{CC(B)}}$	2.3 V to 5.5 V	L	Z	Z
1.65 V to V <sub>CC(B)</sub>	2.3 V to 5.5 V	Н	input or output	output or input
GND[2]	GND[2]	Χ	Z	Z

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

<sup>[2]</sup> When either  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into power-down mode.

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# 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		-0.5	+6.5	V
V <sub>CC(B)</sub>	supply voltage B		-0.5	+6.5	V
VI	input voltage	A port and OE input	[1][2] -0.5	+6.5	V
		B port	[1][2] -0.5	+6.5	V
Vo	output voltage	Active mode	[1][2]		
		A or B port	-0.5	$V_{CCO} + 0.5$	V
		Power-down or 3-state mode	[1]		
		A port	-0.5	+4.6	V
		B port	-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
lok	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
lo	output current	$V_O = 0 V \text{ to } V_{CCO}$	[2] _	±50	mA
Icc	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>	-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	250	mW

<sup>[1]</sup> The minimum input and minimum output voltage ratings may be exceeded if the input and output current ratings are observed.

# 10. Recommended operating conditions

Table 6. Recommended operating conditions[1][2]

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		1.65	3.6	V
$V_{CC(B)}$	supply voltage B		2.3	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	A or B port; push-pull driving			
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	-	10	ns/V
		OE input			
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	-	10	ns/V

<sup>[1]</sup> The A and B sides of an unused I/O pair must be held in the same state, both at  $V_{\text{CCI}}$  or both at GND.

<sup>[2]</sup> V<sub>CCO</sub> is the supply voltage associated with the output.

<sup>[3]</sup> For TSSOP14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 5.5 mW/K. For DHVQFN14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 4.5 mW/K.

<sup>[2]</sup>  $V_{CC(A)}$  must be less than or equal to  $V_{CC(B)}$ .

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# 11. Static characteristics

Table 7. Typical static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T<sub>amb</sub> = 25 °C.

Parameter	Conditions	Min	Тур	Max	Unit
input leakage current	OE input; $V_I$ = 0 V to 3.6 V; $V_{CC(A)}$ = 1.65 V to 3.6 V; $V_{CC(B)}$ = 2.3 V to 5.5 V	-	-	±1	μΑ
OFF-state output current	A or B port; $V_O$ = 0 V or $V_{CCO}$ ; $V_{CC(A)}$ = 1.65 V to 3.6 V; $V_{CC(B)}$ = 2.3 V to 5.5 V	<u>[1]</u> -	-	±1	μА
power-off leakage current	A port; $V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC(A)} = 0$ V; $V_{CC(B)} = 0$ V to 5.5 V	-	-	±1	μА
	B port; $V_1$ or $V_0 = 0$ V to 5.5 V; $V_{CC(B)} = 0$ V; $V_{CC(A)} = 0$ V to 3.6 V	-	-	±1	μА
input capacitance	OE input; $V_{CC(A)} = 3.3 \text{ V}$ ; $V_{CC(B)} = 3.3 \text{ V}$	-	2	-	pF
input/output	A port	-	4	-	pF
capacitance	B port	-	7	-	pF
	A or B port; $V_{CC(A)} = 3.3 \text{ V}$ ; $V_{CC(B)} = 3.3 \text{ V}$	-	9	-	pF
	input leakage current  OFF-state output current power-off leakage current  input capacitance	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

<sup>[1]</sup>  $V_{CCO}$  is the supply voltage associated with the output.

Table 8. Typical supply current

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T<sub>amb</sub> = 25 °C.

V <sub>CC(A)</sub>	V <sub>CC(A)</sub> V <sub>CC(B)</sub>							
	2.5 V		3.3 V	3.3 V				
	I <sub>CC(A)</sub>	I <sub>CC(B)</sub>	I <sub>CC(A)</sub>	I <sub>CC(B)</sub>	I <sub>CC(A)</sub>	I <sub>CC(B)</sub>		
1.8 V	0.1	0.5	0.1	1.5	0.1	4.6	μΑ	
2.5 V	0.1	0.1	0.1	0.8	0.1	3.8	μΑ	
3.3 V	-	-	0.1	0.1	0.1	2.8	μΑ	

Table 9. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C to	+85 °C	–40 °C to ⋅	+125 °C	Unit
			Min	Max	Min	Max	
$V_{IH}$	HIGH-level	A port					
input volta	input voltage	$V_{CC(A)} = 1.65 \text{ V to } 1.95 \text{ V};$ V <sub>CC(B)</sub> = 2.3 V to 5.5 V	V <sub>CCI</sub> - 0.2	-	V <sub>CCI</sub> - 0.2	-	V
		$V_{CC(A)} = 2.3 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	V <sub>CCI</sub> - 0.4	-	$V_{\text{CCI}} - 0.4$	-	V
		B port					
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	V <sub>CCI</sub> - 0.4	-	$V_{\text{CCI}} - 0.4$	-	V
	OE input						
	$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V	

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**Table 9. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		-40 °C 1	to +85 °C	-40 °C to	Uni	
				Min	Max	Min	Max	
/ <sub>IL</sub>	LOW-level	A or B port			'		•	
	input voltage	$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	0.15	-	0.15	V
		OE input						
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
V <sub>ОН</sub>	HIGH-level	A or B port; $I_O = -20 \mu A$						
	output voltage	$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	[2]	0.67V <sub>CCO</sub>	-	0.67V <sub>CCO</sub>	-	V
V <sub>OL</sub>	LOW-level	A or B port; $I_0 = 1 \text{ mA}$	[2]					
	output voltage	$V_I \le 0.15 \text{ V};$ $V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	0.4	-	0.4	V
l	input leakage current	OE input; $V_I = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	±2	-	±12	μА
oz	OFF-state output current	A or B port; $V_O = 0 \text{ V or } V_{CCO}$ ; $V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V}$ ; $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$	[2]	-	±2	-	±12	μА
l <sub>OFF</sub>	power-off leakage	A port; $V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC(A)} = 0$ V; $V_{CC(B)} = 0$ V to 5.5 V		-	±2	-	±12	μΑ
	current	B port; $V_1$ or $V_0$ = 0 V to 3.6 V; $V_{CC(B)}$ = 0 V; $V_{CC(A)}$ = 0 V to 3.6 V		-	±2	-	±12	μΑ
СС	supply current	$V_I = 0 \text{ V or } V_{CCI}; I_O = 0 \text{ A}$	[1]					
		$I_{CC(A)}$						
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	2.4	-	15	μΑ
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2.2	-	15	μΑ
		$V_{CC(A)} = 0 \text{ V}; V_{CC(B)} = 5.5 \text{ V}$		-	-1	-	-8	μΑ
		I <sub>CC(B)</sub>						
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	12	-	30	μА
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	-1	-	-5	μΑ
		$V_{CC(A)} = 0 \text{ V}; V_{CC(B)} = 5.5 \text{ V}$		-	1	-	6	μΑ
		$I_{CC(A)} + I_{CC(B)}$						
		$V_{CC(A)} = 1.65 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 2.3 \text{ V to } 5.5 \text{ V}$		-	14.4	-	45	μΑ

<sup>[1]</sup>  $V_{CCI}$  is the supply voltage associated with the input.

<sup>[2]</sup>  $V_{\text{CCO}}$  is the supply voltage associated with the output.

Dual supply translating transceiver; open drain; auto direction sensing

# 12. Dynamic characteristics

Table 10. Dynamic characteristics for temperature range –40 °C to +85 °C[1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions		V <sub>CC(B)</sub>						Unit
				2.5 V ±	Ŀ 0.2 V		± 0.3 V	5.0 V	± 0.5 V	
				Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.8 V ± 0.15 V	1								
<sup>‡</sup> PHL	HIGH to LOW propagation delay	A to B		-	4.6	-	4.7	-	5.8	ns
PLH	LOW to HIGH propagation delay	A to B		-	6.8	-	6.8	-	7.0	ns
PHL	HIGH to LOW propagation delay	B to A		-	4.4	-	4.5	-	4.7	ns
PLH	LOW to HIGH propagation delay	B to A		-	5.3	-	4.5	-	0.5	ns
en	enable time	OE to A; B		-	200	-	200	-	200	ns
·dis	disable time	OE to A; no external load	[2]	-	35	-	35	-	35	ns
		OE to B; no external load	[2]	-	35	-	35	-	35	ns
		OE to A		-	230	-	230	-	230	ns
		OE to B		-	200	-	200	-	200	ns
t <sub>TLH</sub> LOW to HIGH	A port		3.2	9.5	2.3	9.3	1.8	7.6	ns	
	output transition time	B port		3.3	10.8	2.7	9.1	2.7	7.6	ns
THL	HIGH to LOW	A port		2.0	5.9	1.9	6.0	1.7	13.3	ns
	output transition time	B port		2.9	7.6	2.8	7.5	2.8	10.0	ns
sk(o)	output skew time	between channels	<u>[3]</u>	-	0.7	-	0.7	-	0.7	ns
W	pulse width	data inputs		20	-	20	-	20	-	ns
data	data rate			-	50	-	50	-	50	Mbps
/ <sub>CC(A)</sub> =	2.5 V ± 0.2 V									
PHL	HIGH to LOW propagation delay	A to B		-	3.2	-	3.3	-	3.4	ns
PLH	LOW to HIGH propagation delay	A to B		-	3.5	-	4.1	-	4.4	ns
PHL	HIGH to LOW propagation delay	B to A		-	3.0	-	3.6	-	4.3	ns
PLH	LOW to HIGH propagation delay	B to A		-	2.5	-	1.6	-	0.7	ns
en	enable time	OE to A; B		-	200	-	200	-	200	ns
dis	disable time	OE to A; no external load	[2]	-	35	-	35	-	35	ns
		OE to B; no external load	[2]	-	35	-	35	-	35	ns
		OE to A		-	200	-	200	-	200	ns
		OE to B		-	200	-	200	-	200	ns
TLH	LOW to HIGH	A port		2.8	7.4	2.6	6.6	1.8	6.2	ns
	output transition time	B port		3.2	8.3	2.9	7.9	2.4	6.8	ns

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# Dual supply translating transceiver; open drain; auto direction sensing

Table 10. Dynamic characteristics for temperature range −40 °C to +85 °C[1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions		V <sub>CC(B)</sub>						Unit
				2.5 V :	± 0.2 V	3.3 V	± 0.3 V	5.0 V ± 0.5 V		
				Min	Max	Min	Max	Min	Max	
t <sub>THL</sub>	HIGH to LOW	A port		1.9	5.7	1.9	5.5	1.8	5.3	ns
	output transition time	B port		2.2	7.8	2.4	6.7	2.6	6.6	ns
t <sub>sk(o)</sub>	output skew time	between channels	[3]	-	0.7	-	0.7	-	0.7	ns
$t_{VV}$	pulse width	data inputs		20	-	20	-	20	-	ns
f <sub>data</sub>	data rate			-	50	-	50	-	50	Mbps
$V_{CC(A)} =$	3.3 V ± 0.3 V									
t <sub>PHL</sub>	HIGH to LOW propagation delay	A to B		-	-	-	2.4	-	3.1	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	A to B		-	-	-	4.2	-	4.4	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	B to A		-	-	-	2.5	-	3.3	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	B to A		-	-	-	2.5	-	2.6	ns
t <sub>en</sub>	enable time	OE to A; B		-	-	-	200	-	200	ns
t <sub>dis</sub>	disable time	OE to A; no external load	[2]	-	-	-	35	-	35	ns
		OE to B; no external load	[2]	-	-	-	35	-	35	ns
		OE to A		-	-	-	260	-	260	ns
		OE to B		-	-	-	200	-	200	ns
t <sub>TLH</sub>	LOW to HIGH	A port		-	-	2.3	5.6	1.9	5.9	ns
	output transition time	B port		-	-	2.5	6.4	2.1	7.4	ns
t <sub>THL</sub>	HIGH to LOW	A port		-	-	2.0	5.4	1.9	5.0	ns
	output transition time	B port		-	-	2.3	7.4	2.4	7.6	ns
t <sub>sk(o)</sub>	output skew time	between channels	[3]	-	-	-	0.7	-	0.7	ns
t <sub>W</sub>	pulse width	data inputs		-	-	20	-	20	-	ns
f <sub>data</sub>	data rate			-	-	-	50	-	50	Mbps

<sup>[1]</sup>  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

<sup>[2]</sup> Delay between OE going LOW and when the outputs are actually disabled.

<sup>[3]</sup> Skew between any two outputs of the same package switching in the same direction.

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# Dual supply translating transceiver; open drain; auto direction sensing

Table 11. Dynamic characteristics for temperature range –40 °C to +125 °C[1] Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for wave forms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol Parameter		Conditions		V <sub>CC(B)</sub>								
				2.5 V ± 0.2 V		$3.3 \text{ V} \pm 0.3 \text{ V}$		5.0 V ± 0.5 V				
				Min	Max	Min	Max	Min	Max			
V <sub>CC(A)</sub> =	1.8 V ± 0.15 V											
t <sub>PHL</sub>	HIGH to LOW propagation delay	A to B		-	5.8	-	5.9	-	7.3	ns		
t <sub>PLH</sub>	LOW to HIGH propagation delay	A to B		-	8.5	-	8.5	-	8.8	ns		
<sup>t</sup> PHL	HIGH to LOW propagation delay	B to A		-	5.5	-	5.7	-	5.9	ns		
t <sub>PLH</sub>	LOW to HIGH propagation delay	B to A		-	6.7	-	5.7	-	0.7	ns		
t <sub>en</sub>	enable time	OE to A; B		-	200	-	200	-	200	ns		
t <sub>dis</sub>	disable time	OE to A; no external load	[2]	-	45	-	45	-	45	ns		
		OE to B; no external load	[2]	-	45	-	45	-	45	ns		
		OE to A		-	250	-	250	-	250	ns		
		OE to B		-	220	-	220	-	220	ns		
t <sub>TLH</sub>	LOW to HIGH	A port		3.2	11.9	2.3	11.7	1.8	9.5	ns		
	output transition time	B port		3.3	13.5	2.7	11.4	2.7	9.5	ns		
THL	HIGH to LOW	A port		2.0	7.4	1.9	7.5	1.7	16.7	ns		
	output transition time	B port		2.9	9.5	2.8	9.4	2.8	12.5	ns		
sk(o)	output skew time	between channels	[3]	-	8.0	-	8.0	-	0.8	ns		
t <sub>W</sub>	pulse width	data inputs		20	-	20	-	20	-	ns		
f <sub>data</sub>	data rate			-	50	-	50	-	50	Mbp		
$V_{CC(A)} =$	2.5 V ± 0.2 V											
t <sub>PHL</sub>	HIGH to LOW propagation delay	A to B		-	4.0	-	4.2	-	4.3	ns		
t <sub>PLH</sub>	LOW to HIGH propagation delay	A to B		-	4.4	-	5.2	-	5.5	ns		
PHL	HIGH to LOW propagation delay	B to A		-	3.8	-	4.5	-	5.4	ns		
PLH	LOW to HIGH propagation delay	B to A		-	3.2	-	2.0	-	0.9	ns		
en	enable time	OE to A; B		-	200	-	200	-	200	ns		
dis	disable time	OE to A; no external load	[2]	-	45	-	45	-	45	ns		
		OE to B; no external load	[2]	-	45	-	45	-	45	ns		
		OE to A		-	220	-	220	-	220	ns		
		OE to B		-	220	-	220	-	220	ns		
TLH	LOW to HIGH	A port		2.8	9.3	2.6	8.3	1.8	7.8	ns		
	output transition time	B port		3.2	10.4	2.9	9.7	2.4	8.3	ns		

### Dual supply translating transceiver; open drain; auto direction sensing

Table 11. Dynamic characteristics for temperature range -40 °C to +125 °C[1] ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for wave forms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter Conditions			V <sub>CC(B)</sub>								
				2.5 V :	± 0.2 V		± 0.3 V	5.0 V ± 0.5 V				
				Min	Max	Min	Max	Min	Max			
t <sub>THL</sub>	HIGH to LOW	A port	'	1.9	7.2	1.9	6.9	1.8	6.7	ns		
	output transition time	B port		2.2	9.8	2.4	8.4	2.6	8.3	ns		
t <sub>sk(o)</sub>	output skew time	between channels	[3]	-	0.8	-	0.8	-	0.8	ns		
$t_{W}$	pulse width	data inputs		20	-	20	-	20	-	ns		
f <sub>data</sub>	data rate			-	50	-	50	-	50	Mbps		
V <sub>CC(A)</sub> =	3.3 V ± 0.3 V											
t <sub>PHL</sub>	HIGH to LOW propagation delay	A to B		-	-	-	3.0	-	3.9	ns		
t <sub>PLH</sub>	LOW to HIGH propagation delay	A to B		-	-	-	5.3	-	5.5	ns		
t <sub>PHL</sub>	HIGH to LOW propagation delay	B to A		-	-	-	3.2	-	4.2	ns		
t <sub>PLH</sub>	LOW to HIGH propagation delay	B to A		-	-	-	3.2	-	3.3	ns		
t <sub>en</sub>	enable time	OE to A; B		-	-	-	200	-	200	ns		
t <sub>dis</sub>	disable time	OE to A; no external load	[2]	-	-	-	45	-	45	ns		
		OE to B; no external load	[2]	-	-	-	45	-	45	ns		
		OE to A		-	-	-	280	-	280	ns		
		OE to B		-	-	-	220	-	220	ns		
t <sub>TLH</sub>	LOW to HIGH	A port		-	-	2.3	7.0	1.9	7.4	ns		
	output transition time	B port		-	-	2.5	8.0	2.1	9.3	ns		
t <sub>THL</sub>	HIGH to LOW	A port		-	-	2.0	6.8	1.9	6.3	ns		
	output transition time	B port		-	-	2.3	9.3	2.4	9.5	ns		
t <sub>sk(o)</sub>	output skew time	between channels	[3]	-	-	-	8.0	-	8.0	ns		
t <sub>W</sub>	pulse width	data inputs		-	-	20	-	20	-	ns		
f <sub>data</sub>	data rate			-	-	-	50	-	50	Mbps		

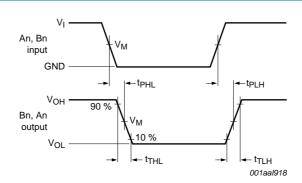
<sup>[1]</sup>  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

<sup>[2]</sup> Delay between OE going LOW and when the outputs are actually disabled.

<sup>[3]</sup> Skew between any two outputs of the same package switching in the same direction.

### Dual supply translating transceiver; open drain; auto direction sensing

# 13. Waveforms



Measurement points are given in Table 12.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

Fig 7. The data input (An, Bn) to data output (Bn, An) propagation delay times

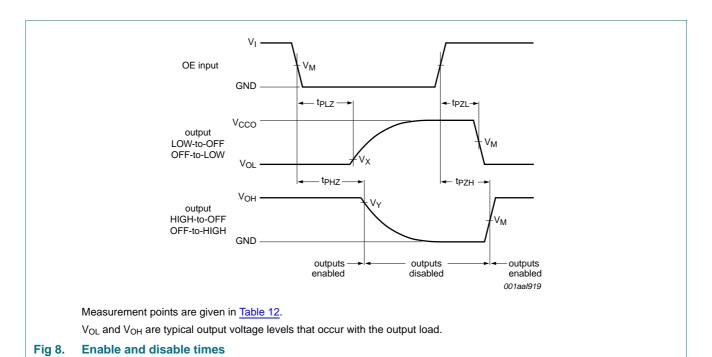


Table 12. Measurement points[1][2]

Supply voltage	Input	Output		
V <sub>CCO</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
1.8 V $\pm$ 0.15 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
$2.5~\textrm{V} \pm 0.2~\textrm{V}$	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
$3.3~\textrm{V} \pm 0.3~\textrm{V}$	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$
$5.0~\textrm{V} \pm 0.5~\textrm{V}$	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$

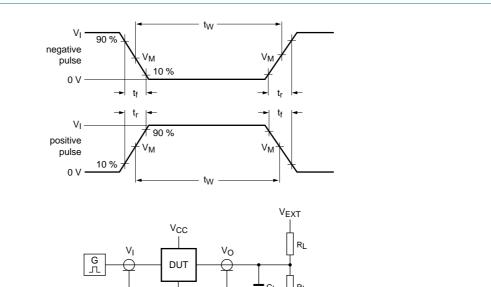
<sup>[1]</sup> V<sub>CCI</sub> is the supply voltage associated with the input.

[2] V<sub>CCO</sub> is the supply voltage associated with the output.

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### Dual supply translating transceiver; open drain; auto direction sensing



Test data is given in Table 13.

All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz;  $Z_0$  = 50  $\Omega$ ;  $dV/dt \geq$  1.0 V/ns.

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $V_{\mathsf{EXT}}$  = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 13. Test data

Supply voltage		Input		Load		V <sub>EXT</sub>		
V <sub>CC(A)</sub>	V <sub>CC(B)</sub>	۷ <sub>ا</sub> [1]	Δt/ΔV	CL	R <sub>L</sub> [2]	$t_{PLH}$ , $t_{PHL}$	$t_{PZH}, t_{PHZ}$	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]
1.65 V to 3.6 V	2.3 V to 5.5 V	$V_{CCI}$	$\leq$ 1.0 ns/V	15 pF	50 kΩ, 1 MΩ	open	open	2V <sub>CCO</sub>

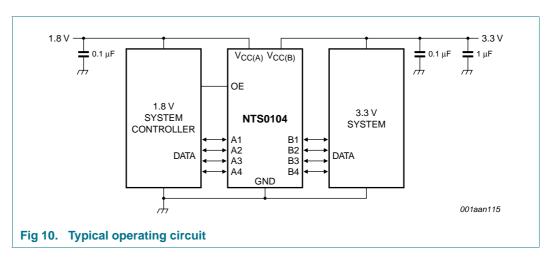
- [1] V<sub>CCI</sub> is the supply voltage associated with the input.
- [2] For measuring data rate, pulse width, propagation delay and output rise and fall measurements,  $R_L = 1 \text{ M}\Omega$ ; for measuring enable and disable times,  $R_L = 50 \text{ k}\Omega$ .
- [3]  $V_{CCO}$  is the supply voltage associated with the output.

Dual supply translating transceiver; open drain; auto direction sensing

# 14. Application information

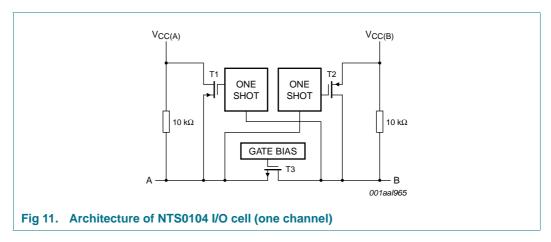
## 14.1 Applications

Voltage level-translation applications. The NTS0104 can be used in point-to-point applications to interface between devices or systems operating at different supply voltages. The device is primarily targeted at I<sup>2</sup>C or 1-wire which use open-drain drivers, it may also be used in applications where push-pull drivers are connected to the ports, however the NTB0104 may be more suitable.



#### 14.2 Architecture

The architecture of the NTS0104 is shown in <u>Figure 11</u>. The device does not require an extra input signal to control the direction of data flow from A to B or B to A.



The NTS0104 is a "switch" type voltage translator, it employs two key circuits to enable voltage translation:

- 1. A pass-gate transistor (N-channel) that ties the ports together.
- 2. An output edge-rate accelerator that detects and accelerates rising edges on the I/O pins.

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### Dual supply translating transceiver; open drain; auto direction sensing

The gate bias voltage of the pass gate transistor (T3) is set at approximately one threshold voltage above the  $V_{CC}$  level of the low-voltage side. During a LOW-to-HIGH transition the output one-shot accelerates the output transition by switching on the PMOS transistors (T1, T2) bypassing the 10 k $\Omega$  pull-up resistors and increasing current drive capability. The one-shot is activated once the input transition reaches approximately  $V_{CCI}/2$ ; it is de-activated approximately 50 ns after the output reaches  $V_{CCO}/2$ . During the acceleration time the driver output resistance is between approximately 50  $\Omega$  and 70  $\Omega$ . To avoid signal contention and minimize dynamic  $I_{CC}$ , the user should wait for the one-shot circuit to turn-off before applying a signal in the opposite direction. Pull-up resistors are included in the device for DC current sourcing capability.

### 14.3 Input driver requirements

As the NTS0104 is a switch type translator, properties of the input driver directly effect the output signal. The external open-drain or push-pull driver applied to an I/O determines the static current sinking capability of the system; the max data rate, HIGH-to-LOW output transition time ( $t_{THL}$ ) and propagation delay ( $t_{PHL}$ ) are dependent upon the output impedance and edge-rate of the external driver. The limits provided for these parameters in the datasheet assume a driver with output impedance below 50  $\Omega$  is used.

### 14.4 Output load considerations

The maximum lumped capacitive load that can be driven is dependant upon the one-shot pulse duration. In cases with very heavy capacitive loading there is a risk that the output will not reach the positive rail within the one-shot pulse duration.

To avoid excessive capacitive loading and to ensure correct triggering of the one-shot it's recommended to use short trace lengths and low capacitance connectors on NTS0104 PCB layouts. To ensure low impedance termination and avoid output signal oscillations and one-shot re-triggering, the length of the PCB trace should be such that the round trip delay of any reflection is within the one-shot pulse duration (approximately 50 ns).

### 14.5 Power up

During operation  $V_{CC(A)}$  must never be higher than  $V_{CC(B)}$ , however during power-up  $V_{CC(A)} \ge V_{CC(B)}$  does not damage the device, so either power supply can be ramped up first. There is no special power-up sequencing required. The NTS0104 includes circuitry that disables all output ports when either  $V_{CC(A)}$  or  $V_{CC(B)}$  is switched off.

#### 14.6 Enable and disable

An output enable input (OE) is used to disable the device. Setting OE = LOW

causes all I/Os to assume the high-impedance OFF-state. The disable time ( $t_{dis}$  with no external load) indicates the delay between when OE goes LOW and when outputs actually become disabled. The enable time ( $t_{en}$ ) indicates the amount of time the user must allow for one one-shot circuitry to become operational after OE is taken HIGH. To ensure the high-impedance OFF-state during power-up or power-down, pin OE should be tied to GND through a pull-down resistor, the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Dual supply translating transceiver; open drain; auto direction sensing

# 14.7 Pull-up or pull-down resistors on I/Os lines

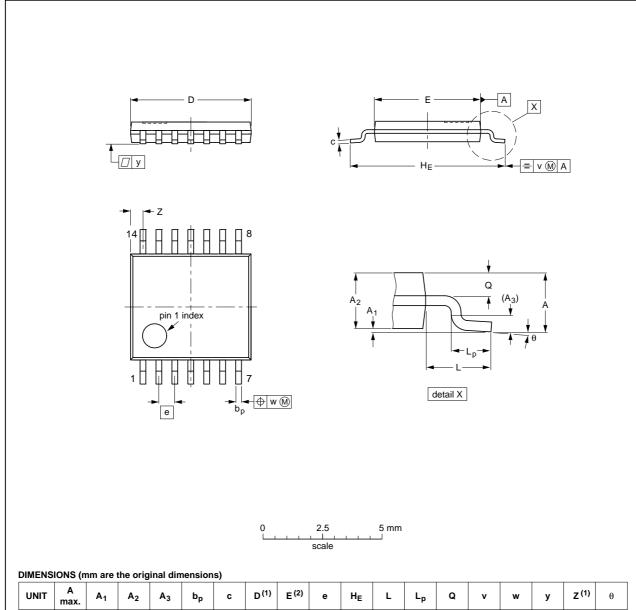
Each A port I/O has an internal 10 k $\Omega$  pull-up resistor to  $V_{CC(A)}$ , and each B port I/O has an internal 10 k $\Omega$  pull-up resistor to  $V_{CC(B)}$ . If a smaller value of pull-up resistor is required, an external resistor must be added parallel to the internal 10 k $\Omega$ , this will effect the  $V_{OL}$  level. When OE goes LOW the internal pull-ups of the NTS0104 are disabled.

Dual supply translating transceiver; open drain; auto direction sensing

# 15. Package outline

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	e	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included

	REFER	EUROPEAN	ISSUE DATE			
IEC	JEDEC	JEITA		PROJECTION	IOOUL DATE	
	MO-153				<del>99-12-27</del> 03-02-18	
	IEC	IEC JEDEC		IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION	

Fig 12. Package outline SOT402-1 (TSSOP14)

NTS010

### Dual supply translating transceiver; open drain; auto direction sensing

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

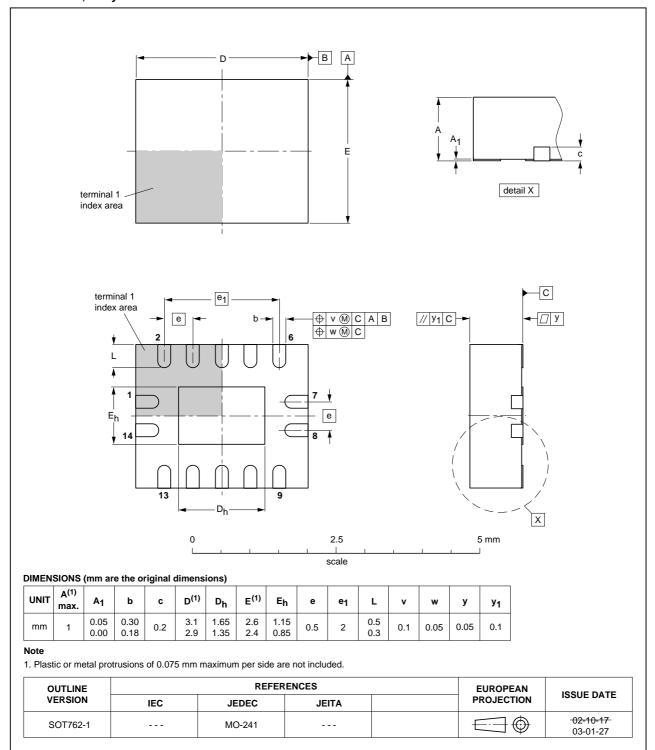


Fig 13. Package outline SOT762-1 (DHVQFN14)

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### Dual supply translating transceiver; open drain; auto direction sensing

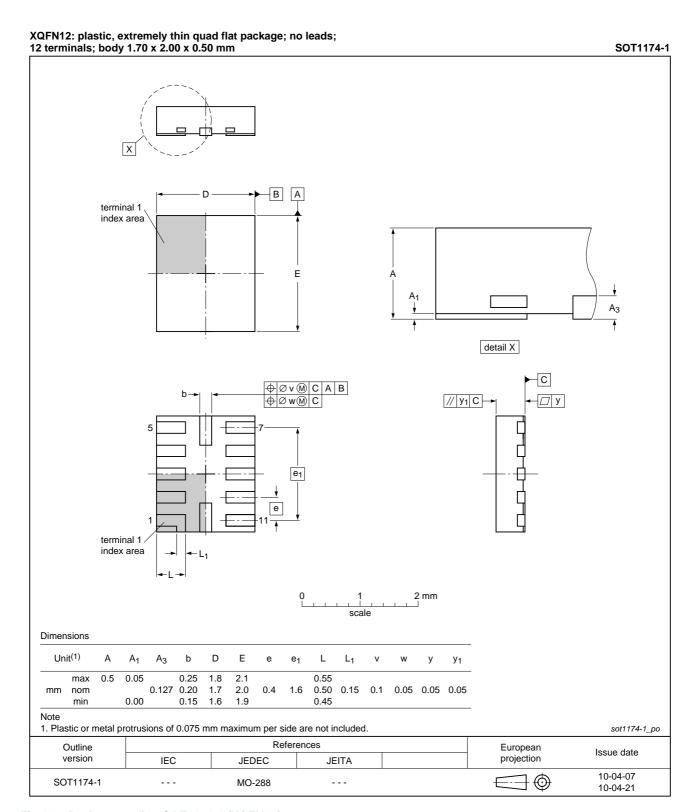


Fig 14. Package outline SOT1174-1 (XQFN12)

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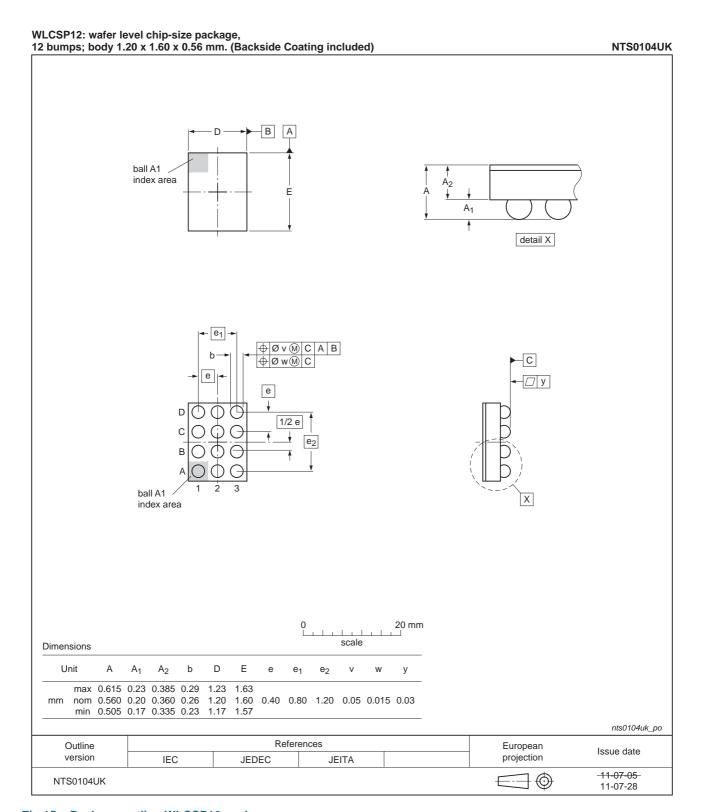


Fig 15. Package outline WLCSP12 package

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# Dual supply translating transceiver; open drain; auto direction sensing

# 16. Abbreviations

### Table 14. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
GPIO	General Purpose Input Output
НВМ	Human Body Model
I <sup>2</sup> C	Inter-Integrated Circuit
MM	Machine Model
SMBus	System Management Bus
UART	Universal Asynchronous Receiver Transmitter

# 17. Revision history

# Table 15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NTS0104 v.3	20120103	Product data sheet	-	NTS0104 v.2
Modifications:	<ul><li>NTS0104UI</li><li>NTS0104D</li></ul>			
NTS0104 v.2	20110427	Product data sheet	-	NTS0104 v.1
NTS0104 v.1	20101125	Product data sheet	-	-

### Dual supply translating transceiver; open drain; auto direction sensing

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#### 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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# Dual supply translating transceiver; open drain; auto direction sensing

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